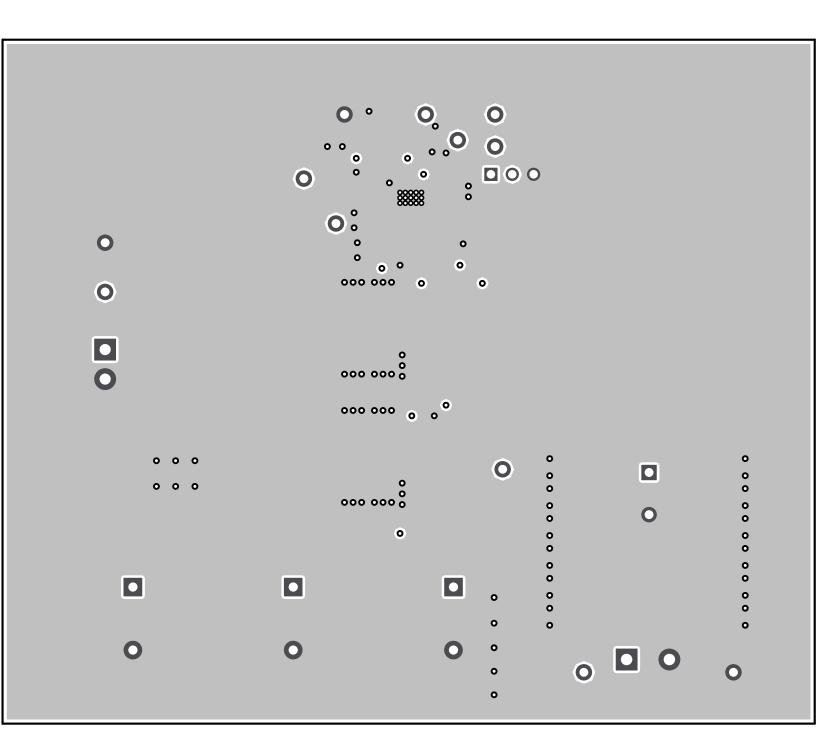
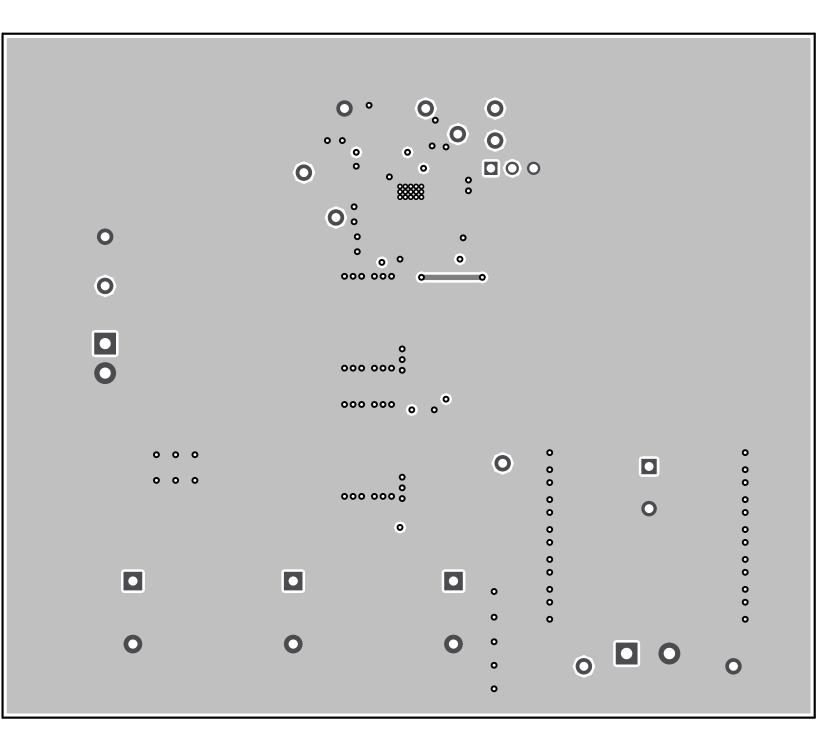


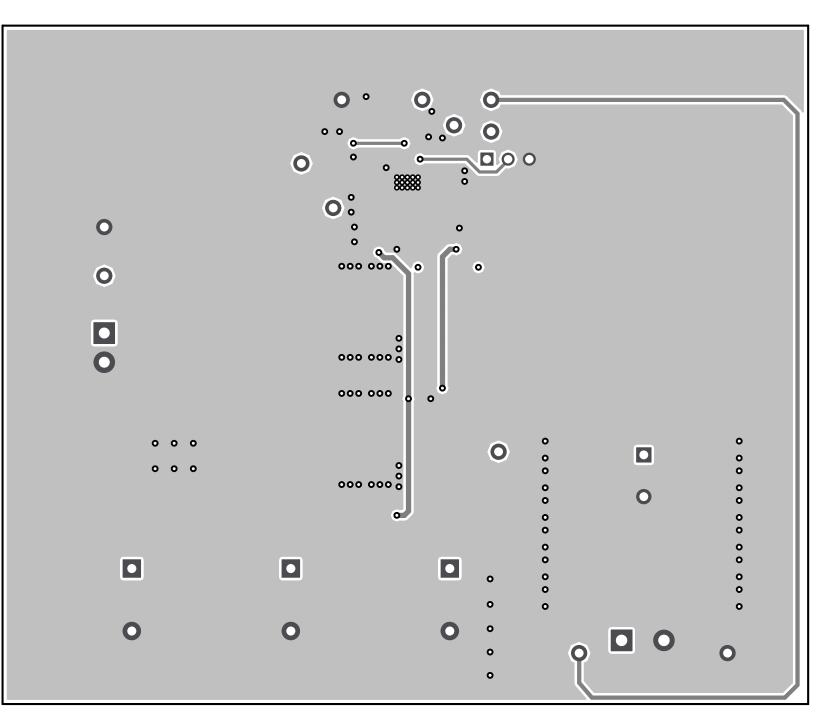
PMP6680 REV A LAYER 1-TOP



LAYER 2



LAYER 3



LAYER 4-BOTTOM

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